

1. Description

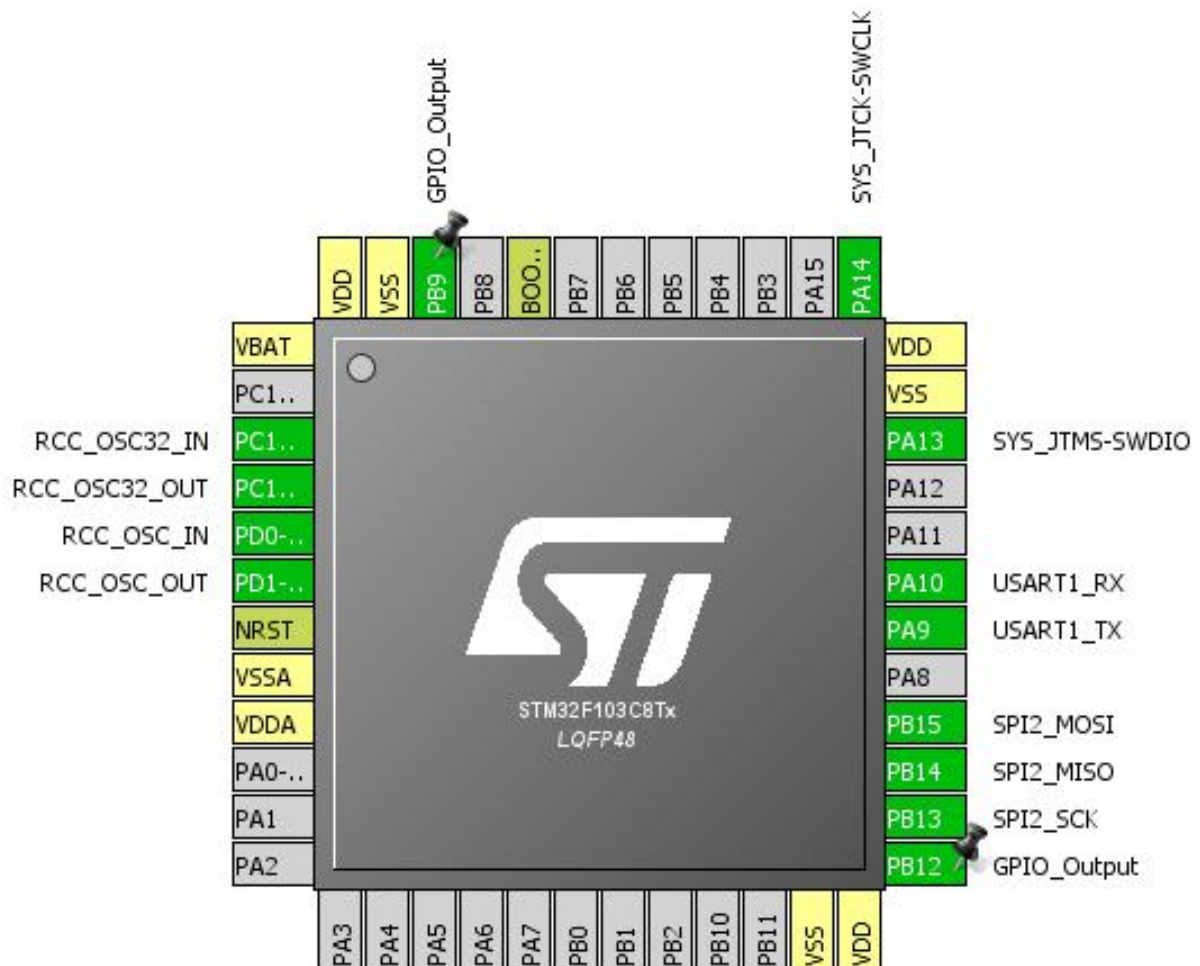
1.1. Project

Project Name	STM32v11test
Board Name	custom
Generated with:	STM32CubeMX 4.26.1
Date	07/28/2018

1.2. MCU

MCU Series	STM32F1
MCU Line	STM32F103
MCU name	STM32F103C8Tx
MCU Package	LQFP48
MCU Pin number	48

2. Pinout Configuration

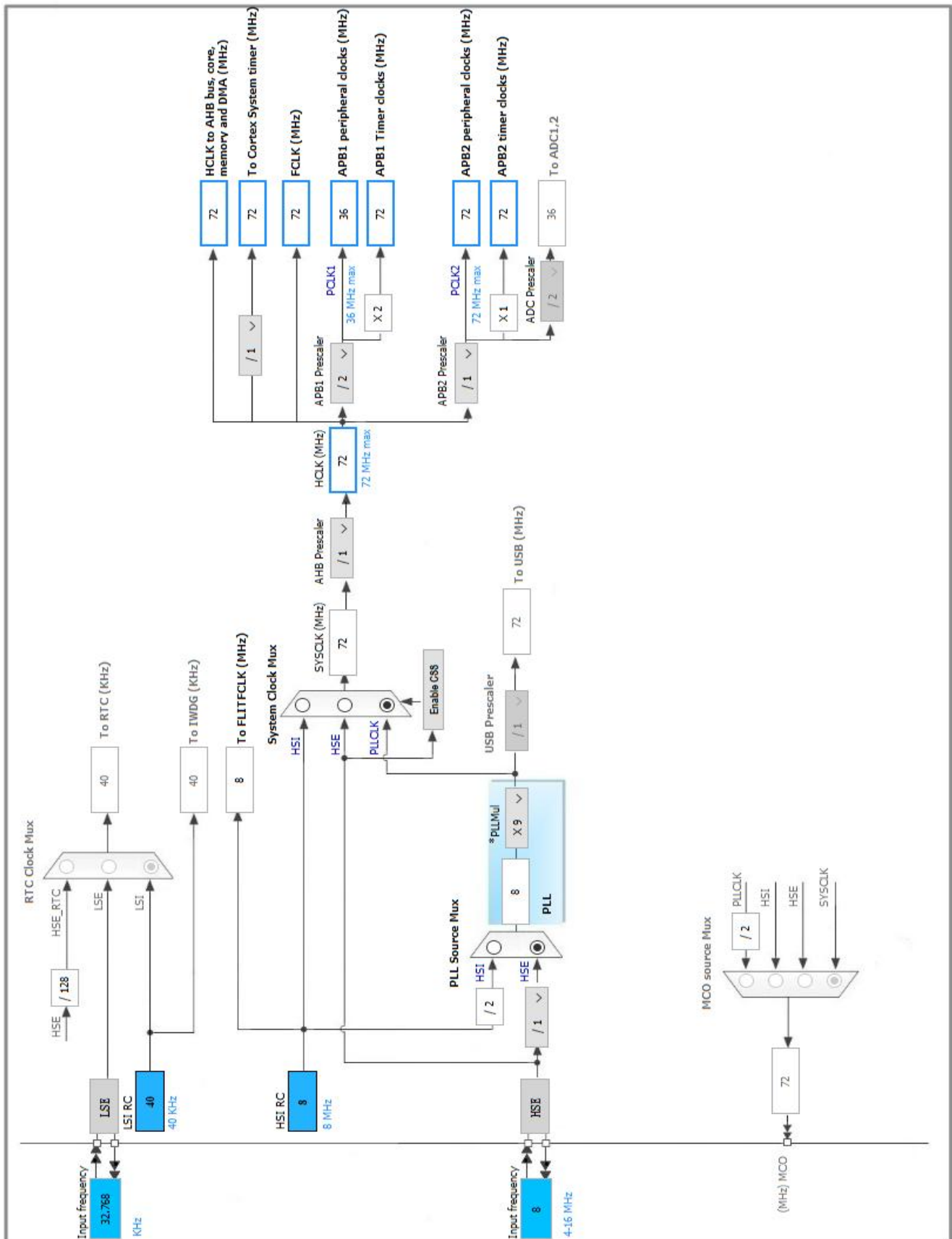


3. Pins Configuration

Pin Number LQFP48	Pin Name (function after reset)	Pin Type	Alternate Function(s)	Label
1	VBAT	Power		
3	PC14-OSC32_IN	I/O	RCC_OSC32_IN	
4	PC15-OSC32_OUT	I/O	RCC_OSC32_OUT	
5	PD0-OSC_IN	I/O	RCC_OSC_IN	
6	PD1-OSC_OUT	I/O	RCC_OSC_OUT	
7	NRST	Reset		
8	VSSA	Power		
9	VDDA	Power		
23	VSS	Power		
24	VDD	Power		
25	PB12 *	I/O	GPIO_Output	
26	PB13	I/O	SPI2_SCK	
27	PB14	I/O	SPI2_MISO	
28	PB15	I/O	SPI2_MOSI	
30	PA9	I/O	USART1_TX	
31	PA10	I/O	USART1_RX	
34	PA13	I/O	SYS_JTMS-SWDIO	
35	VSS	Power		
36	VDD	Power		
37	PA14	I/O	SYS_JTCK-SWCLK	
44	BOOT0	Boot		
46	PB9 *	I/O	GPIO_Output	
47	VSS	Power		
48	VDD	Power		

* The pin is affected with an I/O function

4. Clock Tree Configuration



5. IPs and Middleware Configuration

5.1. RCC

High Speed Clock (HSE): Crystal/Ceramic Resonator

Low Speed Clock (LSE) : Crystal/Ceramic Resonator

5.1.1. Parameter Settings:

System Parameters:

VDD voltage (V)	3.3
Prefetch Buffer	Enabled
Flash Latency(WS)	2 WS (3 CPU cycle)

RCC Parameters:

HSI Calibration Value	16
HSE Startup Timeout Value (ms)	100
LSE Startup Timeout Value (ms)	5000

5.2. SPI2

Mode: Full-Duplex Master

5.2.1. Parameter Settings:

Basic Parameters:

Frame Format	Motorola
Data Size	8 Bits
First Bit	MSB First

Clock Parameters:

Prescaler (for Baud Rate)	2
Baud Rate	18.0 MBits/s *
Clock Polarity (CPOL)	Low
Clock Phase (CPHA)	2 Edge *

Advanced Parameters:

CRC Calculation	Disabled
NSS Signal Type	Software

5.3. SYS

Debug: Serial Wire

Timebase Source: SysTick

5.4. USART1

Mode: Asynchronous

5.4.1. Parameter Settings:

Basic Parameters:

Baud Rate	115200
Word Length	8 Bits (including Parity)
Parity	None
Stop Bits	1

Advanced Parameters:

Data Direction	Receive and Transmit
Over Sampling	16 Samples

*** User modified value**

6. System Configuration

6.1. GPIO configuration

IP	Pin	Signal	GPIO mode	GPIO pull/up pull down	Max Speed	User Label
RCC	PC14-OSC32_IN	RCC_OSC32_IN	n/a	n/a	n/a	
	PC15-OSC32_OUT	RCC_OSC32_OUT	n/a	n/a	n/a	
	PD0-OSC_IN	RCC_OSC_IN	n/a	n/a	n/a	
	PD1-OSC_OUT	RCC_OSC_OUT	n/a	n/a	n/a	
SPI2	PB13	SPI2_SCK	Alternate Function Push Pull	n/a	High *	
	PB14	SPI2_MISO	Input mode	No pull-up and no pull-down	n/a	
	PB15	SPI2_MOSI	Alternate Function Push Pull	n/a	High *	
SYS	PA13	SYS_JTMS-SWDIO	n/a	n/a	n/a	
	PA14	SYS_JTCK-SWCLK	n/a	n/a	n/a	
USART1	PA9	USART1_TX	Alternate Function Push Pull	n/a	High *	
	PA10	USART1_RX	Input mode	No pull-up and no pull-down	n/a	
GPIO	PB12	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	
	PB9	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	

6.2. DMA configuration

nothing configured in DMA service

6.3. NVIC configuration

Interrupt Table	Enable	Preenmption Priority	SubPriority
Non maskable interrupt	true	0	0
Hard fault interrupt	true	0	0
Memory management fault	true	0	0
Prefetch fault, memory access fault	true	0	0
Undefined instruction or illegal state	true	0	0
System service call via SWI instruction	true	0	0
Debug monitor	true	0	0
Pendable request for system service	true	0	0
System tick timer	true	0	0
PVD interrupt through EXTI line 16	unused		
Flash global interrupt	unused		
RCC global interrupt	unused		
SPI2 global interrupt	unused		
USART1 global interrupt	unused		

* User modified value

7. Power Consumption Calculator report

7.1. Microcontroller Selection

Series	STM32F1
Line	STM32F103
MCU	STM32F103C8Tx
Datasheet	13587_Rev17

7.2. Parameter Selection

Temperature	25
Vdd	3.3

8. Software Pack Report